

Notice of References Cited		Application/Control No.	Applicant(s)/Patent Under Reexamination	
		10/734,593	KUNDALGURKI, SRIVATSA	
Examiner		Art Unit		Page 1 of 1
Evan Pert		2826		

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-6,630,406 B2	10-2003	Waldfried et al.	438/710
	B	US-6,562,700	05-2003	Gu et al.	438/477
	C	US-6,492,272	12-2002	Okada et al.	438/690
	D	US-6,030,901	02-2000	Hopper et al.	438/711
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	K. R. Williams et al., "Etch Rates for Micromachining Processing - Part II" December 2003, Vol. 12, Issue 6, pages 761-778.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.